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# 5145299-2 Product Details



5145299-2

Smart Card Connectors

Always EU RoHS/ELV Compliant (Statement of Compliance)

#### Product Highlights:

- Connector
- 8 Positions
- With Card Guide Slots
- Not Stacked
- Height Above PC Board = 4.05 mm

View all Features



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TE Internal Number: 5145299-2













#### **Documentation & Additional Information**

#### Product Drawings:

SIM/SAM CONNECTOR WITH LID, 8 POSN OR 6 POSN WITH SW... (PDF, English)

#### Catalog Pages/Data Sheets:

None Available

#### Product Specifications:

Connector, SIM/SAM (PDF, English)

#### Application Specifications:

Subscriber Identity Module/Security Access Module (S... (PDF, English)

#### **Instruction Sheets:**

None Available

#### CAD Files: (CAD Format & Compression Information)

- 2D Drawing (DXF, Version 0)
- 3D Model (IGES, Version O)
- 3D Model (STEP, Version O)

#### Additional Information:

Product Line Information

#### Related Products:

Tooling



### Product Features (Please use the Product Drawing for all design activity)

### Product Type Features:

- Product Type = Connector
- Card Guide Slots = With
- Stacked = No
- Termination Type = IDC
- PCB Mount Style = Surface Mount

## **Termination Features:**

Solder Tail Contact Plating = Tin over Nickel

## Dimensions:

- Height Above PC Board (mm [in]) = 4.05 [0.159]
- Height off PCB (mm [in]) = 1.55 [0.059]

### **Body Features:**

- Mount Style = Surface Mount
- Card Scoop = With
- Durability Rating = 10,000 Cycles

### Contact Features:

- Number of Signal Contacts = 8
- Contact Base Material = Phosphor Bronze
- Contact Plating, Mating Area, Material = Gold

### **Housing Features:**

List all Documents

- Housing Color = Black
- Housing Material = High Temperature Thermoplastic

### Configuration Features:

- Number of Positions = 8
- Cable = Without
- Card Detection Switch = Without

### **Industry Standards:**

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Reflow solder capable to 245°C, Reflow solder capable to 260°C
- RoHS/ELV Compliance History = Always was RoHS compliant.

### Conditions for Usage:

Accepts Card Thickness (mm [in]) = 0.76 [0.030]

### Other:

- Brand = AMP
- Comment = Has Stainless Steel Locking Disk; Designed to accept GSM 11.11 SIM (Subscriber Identity Module) and SAM (Security) Access Module) Integrated Circuit Cards, Has Stainless Steel Locking Disk.

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